The RF Line

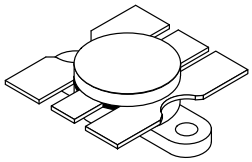
NPN Silicon RF Power Transistor

MRF316

. . . designed primarily for wideband large–signal output amplifier stages in the 30–200 MHz frequency range.

- Guaranteed Performance at 150 MHz, 28 Vdc
  Output Power = 80 Watts
  Minimum Gain = 10 dB
- Built–In Matching Network for Broadband Operation
- 100% Tested for Load Mismatch at all Phase Angles with 30:1 VSWR
- Gold Metallization System for High Reliability Applications

80 W, 3.0 – 200 MHz
CONTROLLED "Q"
BROADBAND RF POWER
TRANSISTOR
NPN SILICON



CASE 316–01, STYLE 1

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	35	Vdc
Collector–Base Voltage	V_{CBO}	65	Vdc
Emitter–Base Voltage	V_{EBO}	4.0	Vdc
Collector Current — Continuous Peak	I_C	9.0 13.5	Adc
Total Device Dissipation @ T_C = 25°C (1) Derate above 25°C	P_D	220 1.26	Watts W/°C
Storage Temperature Range	T_{stg}	–65 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.8	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

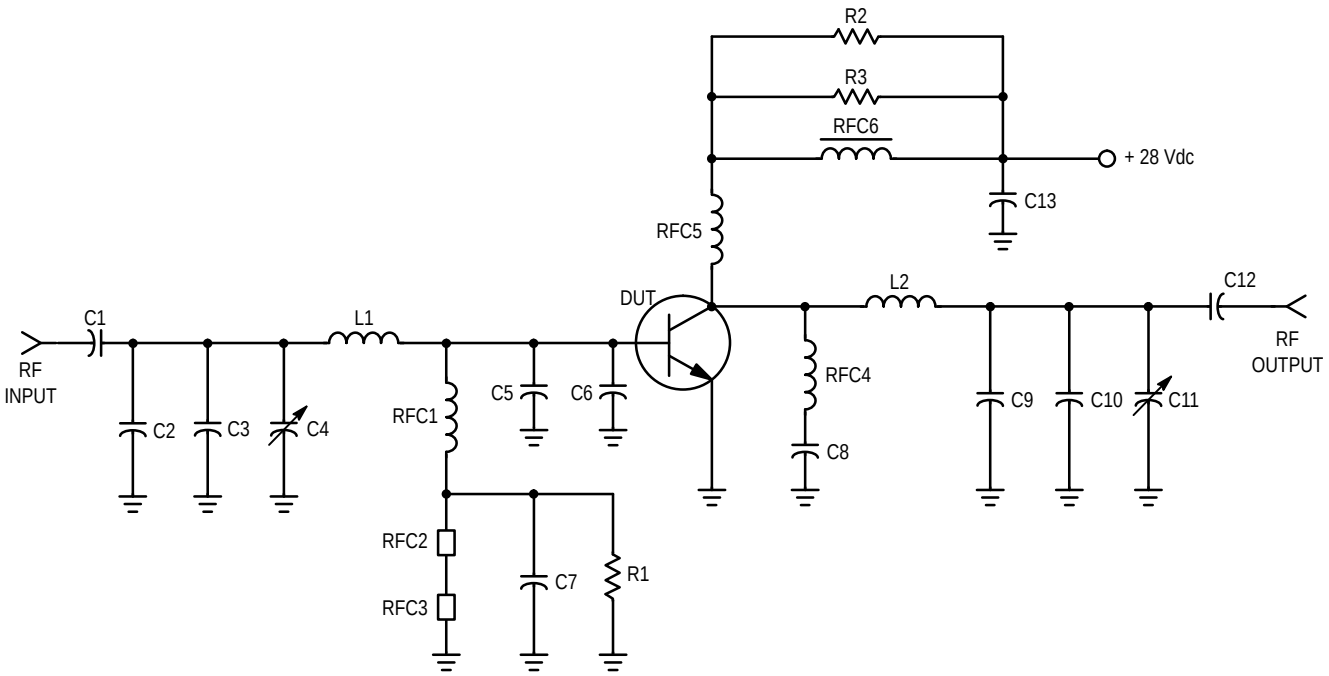
Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Breakdown Voltage (I_C = 50 mAdc, I_B = 0)	$V_{(BR)CEO}$	35	—	—	Vdc
Collector–Emitter Breakdown Voltage (I_C = 50 mAdc, V_{BE} = 0)	$V_{(BR)CES}$	65	—	—	Vdc
Collector–Base Breakdown Voltage (I_C = 50 mAdc, I_E = 0)	$V_{(BR)CBO}$	65	—	—	Vdc
Emitter–Base Breakdown Voltage (I_E = 5.0 mAdc, I_C = 0)	$V_{(BR)EBO}$	4.0	—	—	Vdc
Collector Cutoff Current (V_{CB} = 30 Vdc, I_E = 0)	I_{CBO}	—	—	5.0	mAdc
ON CHARACTERISTICS					
DC Current Gain (I_C = 4.0 Adc, V_{CE} = 5.0 Vdc)	h_{FE}	10	—	80	—
DYNAMIC CHARACTERISTICS					
Output Capacitance (V_{CB} = 28 Vdc, I_E = 0, f = 1.0 MHz)	C_{ob}	—	130	200	pF

NOTE: (continued)

1. This device is designed for RF operation. The total device dissipation rating applies only when the device is operated as an RF amplifier.

ELECTRICAL CHARACTERISTICS — continued (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
NARROW BAND FUNCTIONAL TESTS (Figure 1)					
Common–Emitter Amplifier Power Gain (V_{CC} = 28 Vdc, P_{out} = 80 W, f = 150 MHz)	G_{PE}	10	13	—	dB
Collector Efficiency (V_{CC} = 28 Vdc, P_{out} = 80 W, f = 150 MHz)	η	55	—	—	%
Load Mismatch (V_{CC} = 28 Vdc, P_{out} = 80 W CW, f = 150 MHz, VSWR = 30:1 all phase angles)	ψ	No Degradation in Output Power			



C1 — 22 pF 100 mil ATC
C2, C3 — 24 pF 100 mil ATC
C4, C11 — 0.8–20 pF JMC #5501 Johanson
C5 — 200 pF 100 mil ATC
C6 — 240 pF 100 mil ATC
C7 — Dipped Mica 1000 pF
C8 — 0.1 μF Erie Red Cap
C9, C10, C12 — 30 pF 100 mil ATC
C13 — 1.0 μF Tantalum

L1 — 0.8″, #20 Wire
L2 — 1.0″, #20 Wire
RFC1, RFC4 — 0.15 μH Molded Coil
RFC2, RFC3 — Ferroxcube Bead 56–590–65–3B
RFC5 — 2.5″, #20 Wire, 1.5 Turns
RFC6 — Ferroxcube VK200–19/4B
R1 — 10 Ω, 1/2 W
R2, R3 — 10 Ω, 1.0 W

Figure 1. 150 MHz Test Amplifier

TYPICAL PERFORMANCE CURVES

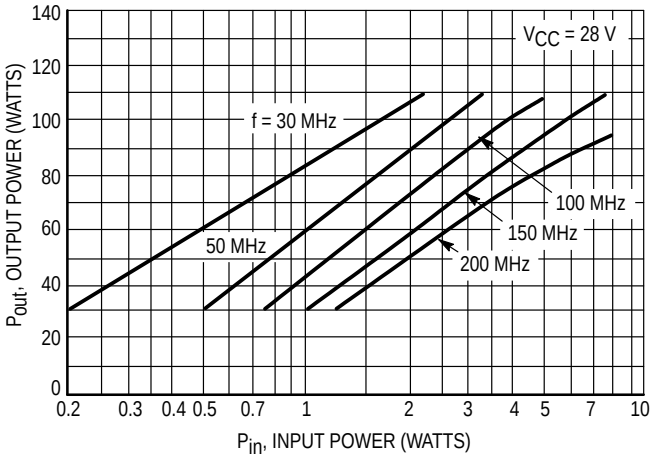


Figure 2. Output Power versus Input Power

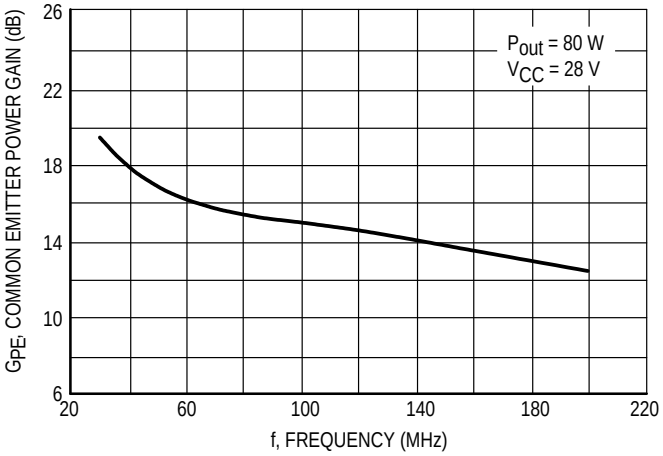


Figure 3. Power Gain versus Frequency

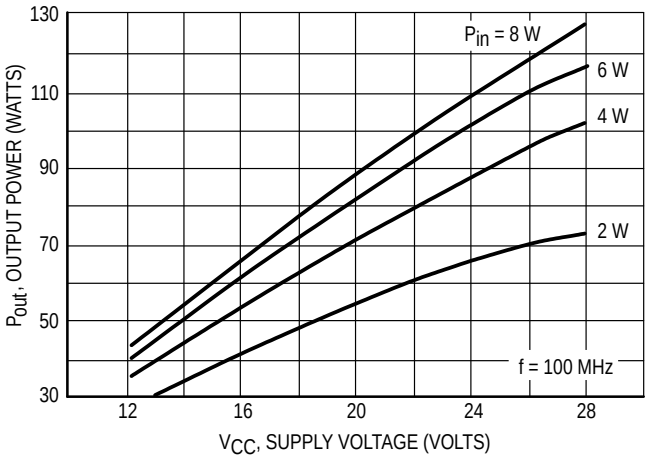


Figure 4. Output Power versus Supply Voltage

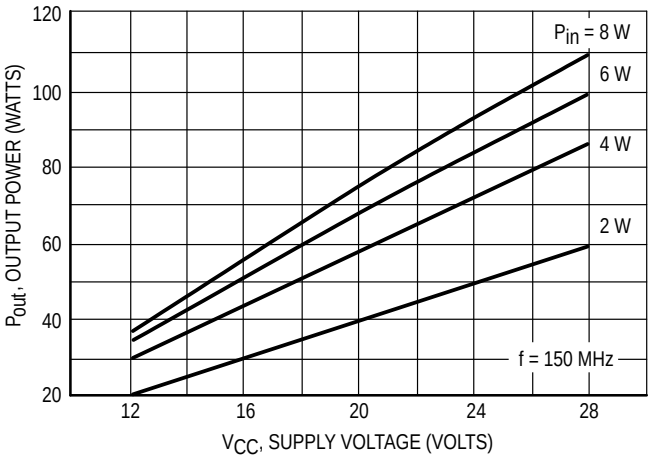


Figure 5. Output Power versus Supply Voltage

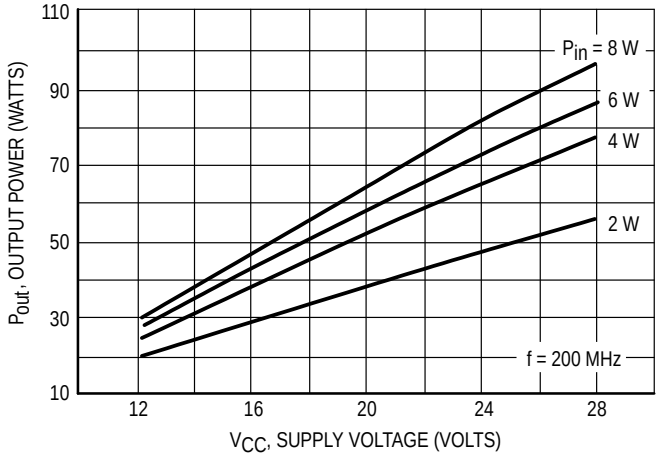
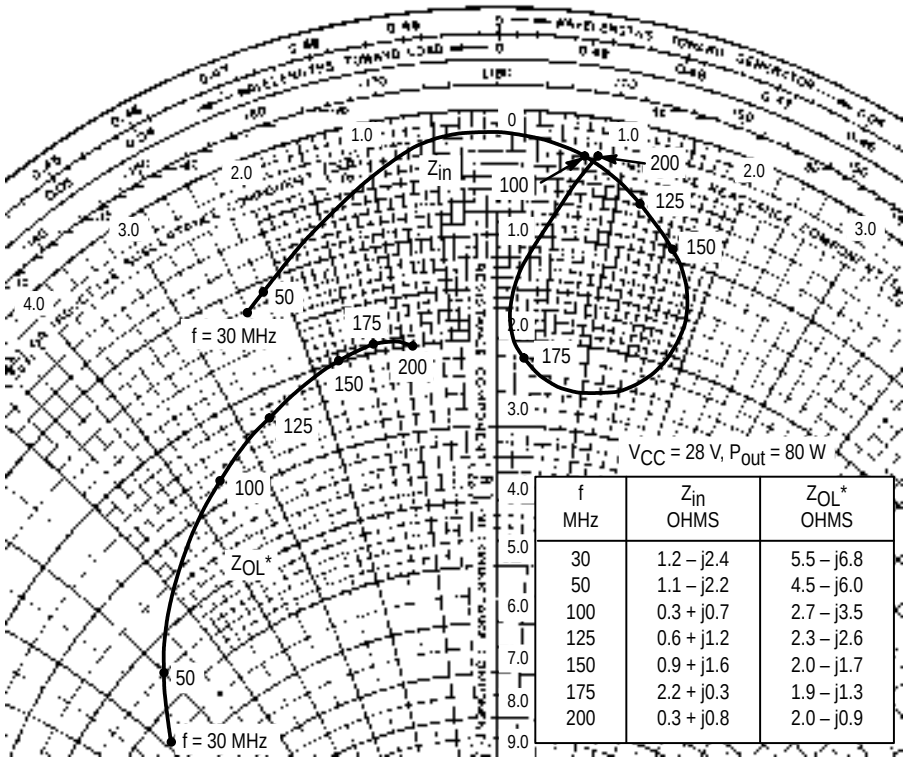


Figure 6. Output Power versus Supply Voltage

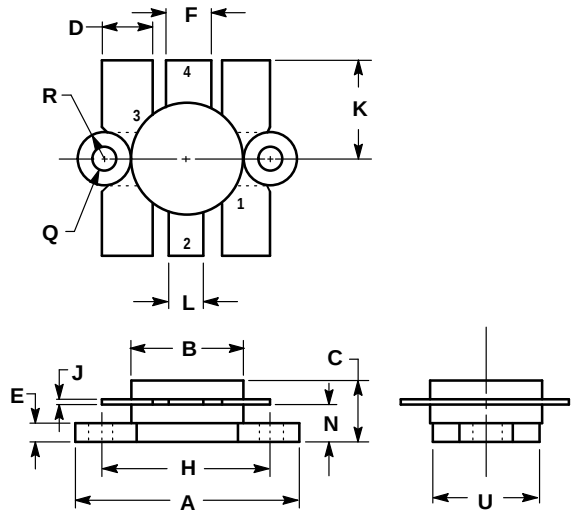


f MHz	Z_{in} OHMS	Z_{OL}* OHMS
30	1.2 – j2.4	5.5 – j6.8
50	1.1 – j2.2	4.5 – j6.0
100	0.3 + j0.7	2.7 – j3.5
125	0.6 + j1.2	2.3 – j2.6
150	0.9 + j1.6	2.0 – j1.7
175	2.2 + j0.3	1.9 – j1.3
200	0.3 + j0.8	2.0 – j0.9

Z_{OL}* = Conjugate of the optimum loadimpedance into which the device output operates at a given output power voltage and frequency.

Figure 7. Series Equivalent Input–Output Impedance

PACKAGE DIMENSIONS



NOTES:
1. FLANGE IS ISOLATED IN ALL STYLES.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	24.38	25.14	0.960	0.990
B	12.45	12.95	0.490	0.510
C	5.97	7.62	0.235	0.300
D	5.33	5.58	0.210	0.220
E	2.16	3.04	0.085	0.120
F	5.08	5.33	0.200	0.210
H	18.29	18.54	0.720	0.730
J	0.10	0.15	0.004	0.006
K	10.29	11.17	0.405	0.440
L	3.81	4.06	0.150	0.160
N	3.81	4.31	0.150	0.170
Q	2.92	3.30	0.115	0.130
R	3.05	3.30	0.120	0.130
U	11.94	12.57	0.470	0.495

STYLE 1:
PIN 1. EMITTER
2. COLLECTOR
3. EMITTER
4. BASE

CASE 316–01
ISSUE D

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